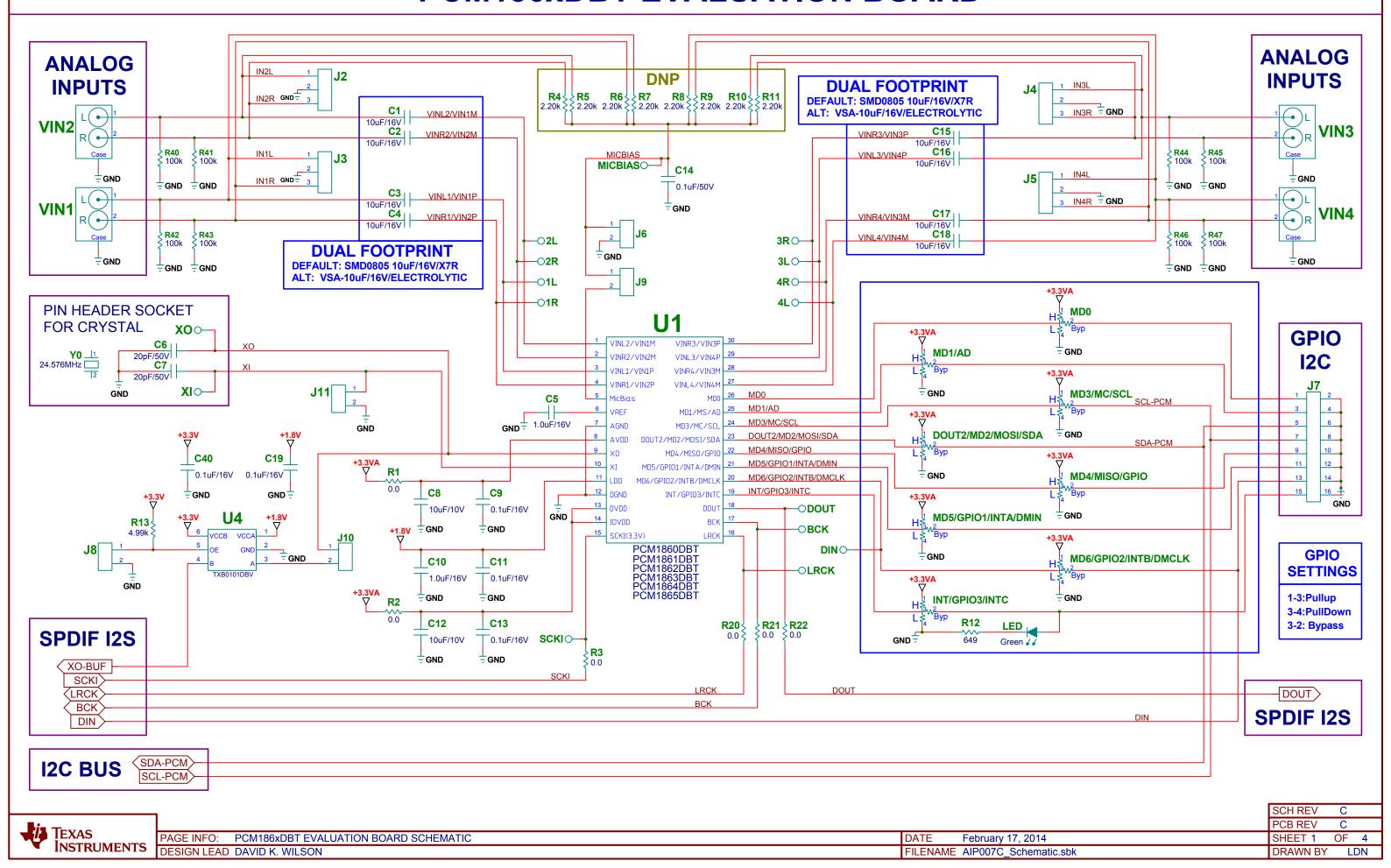
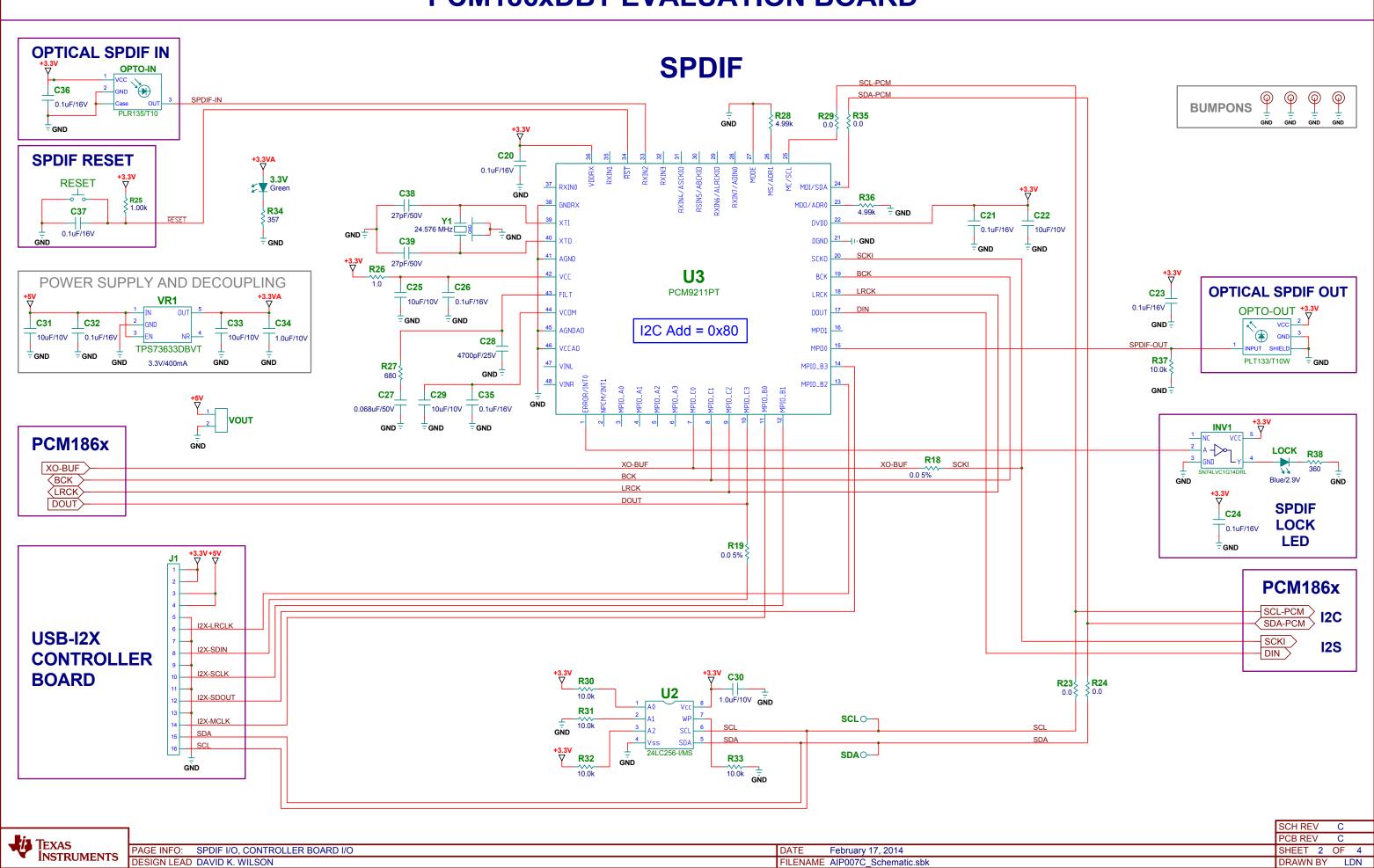
## PCM186xDBT EVALUATION BOARD



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REVISION HISTORY					
REVISION	DESCRIPTION	DATE	APPROVAL		
В	INITIAL RELEASE	SEPTEMBER 18, 2013	DKW		
С	1. REVERSED CONNECTIONS BETWEEN MD3/MC/SCL-2 AND DOUT2/MD2/MOSI/SDA-2	February 17, 2014	DKW		

AIP007-001	PCM1860EVM
AIP007-002	PCM1861EVM
AIP007-003	PCM1862EVM
AIP007-004	PCM1863EVM
AIP007-005	PCM1864EVM
AIP007-006	PCM1865EVM

		SCH REV C
	BOARD NAME: SEE CHART ABOVE	PCB REV C
GE INFO: REVISION HISTORY	DATE February 17, 2014	SHEET 3 OF 4
SIGN LEAD DAVID K. WILSON	FILENAME AIP007C_Schematic.sbk	DRAWN BY LDN

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